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APPLICATION NO.	FIL	LING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO	
10/737,119	1:	2/17/2003	Hiroshi Kuroda	XA-10006	5995	
181	7590	05/31/2006		EXAMINER		
MILES &	STOCKBE	RIDGE PC	NGUYEN, DILINH P			
1751 PINNA SUITE 500		VE	ART UNIT	PAPER NUMBER		
MCLEAN,		2-3833	2814			
				DATE MAILED: 05/31/2000	DATE MAILED: 05/31/2006	

Please find below and/or attached an Office communication concerning this application or proceeding.

311	

	Application No.	Applicant(s)						
	10/737,119	KURODA ET AL.						
Office Action Summary	Examiner	Art Unit						
	DiLinh Nguyen	2814						
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence address						
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DATE - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. If NO period for reply is specified above, the maximum statutory period varieties or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tim will apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).						
Status								
1) Responsive to communication(s) filed on 23 M	ay 2006.							
•—	<u> </u>							
3) Since this application is in condition for allowar								
closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.								
Disposition of Claims								
4)⊠ Claim(s) <u>1-3 and 6-12</u> is/are pending in the application.								
4a) Of the above claim(s) is/are withdrawn from consideration.								
5) Claim(s) is/are allowed.								
6)⊠ Claim(s) <u>1-3 and 6-12</u> is/are rejected.								
7) Claim(s) is/are objected to.								
8) Claim(s) are subject to restriction and/or election requirement.								
Application Papers								
9)☐ The specification is objected to by the Examine								
10) ☐ The drawing(s) filed on is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.								
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).								
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).								
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.								
Priority under 35 U.S.C. § 119								
12)⊠ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a)⊠ All b)□ Some * c)□ None of:								
2. Certified copies of the priority documents have been received in Application No								
3. Copies of the certified copies of the priority documents have been received in this National Stage								
application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received.								
Gee the attached detailed Office action for a list of the certified copies not received.								
Attachment(s)	, -	· (PTO, 442)						
1) Notice of References Cited (PTO-892) 4) Interview Summary (PTO-413) Paper No(s)/Mail Date								
3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) 5) Notice of Informal Patent Application (PTO-152)								
Paper No(s)/Mail Date 6)								

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DETAILED ACTION

Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 1-3 and 6-12 are rejected under 35 U.S.C. 103(a) as being unpatentable over Hiroaki et al. (JP. 2001-291821) (previously applied) in view of Kanemoto et al. (U.S. Pat. 6410987).
- Regarding claims 1 and 6, Hiroaki et al. disclose a semiconductor device comprising:

a wiring substrate 8;

an upper chip 14; and

a lower chip 10 or 12, the upper chip and the lower chip being mounted over an upper surface of the wiring substrate, and

wherein the upper chip is constructed as a multiport device including an interface between the upper chip and another part of the system including the lower chip and an interference between the upper chip and outside of the system,

wherein the lower chip is constructed to be accessed from the outside of the system via the upper chip,

wherein the upper chip 14 has a substantially square planar shape,

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wherein the lower chip 10 or 12 has a substantially rectangular planar shape, with a long side having a greater length than a side thereof adjacent to the long side,

wherein a length of a side of the upper chip 14 is shorter than a length of a long side of the lower chip, and

wherein the upper chip 14 is mounted over the wiring substrate 8 in as state being stacked over the lower chip 10 or 12 (fig. 1, abstract).

Hiroaki et al. do not explicitly disclose the upper chip and lower chips are the microcomputer chip or the memory chip.

However, Kanemoto et al. disclose a semiconductor device comprising: a square ASIC (microcomputer) chip 2 is stacked over a rectangular flash memory chip 3 (fig. 5, column 9, lines 33-42). Therefore, it would have been obvious to one having ordinary in the art at the time the invention was made to select the flash memory chip or the microcomputer chip in the chips of Hiroaki et al. because it has been held that a recitation with respect to the manner in which a claimed apparatus is intended to be employed does not differentiate the claimed apparatus from a prior art apparatus satisfying the claimed structural limitations. Ex Parte Masham, 2 USPQ F.2d 1647 (1987).

• Regarding claim 2, Hiroaki et al. discloses that the upper chip 14 is connected to first electrodes of said wiring substrate 8 via a plurality of bonding wires 19, the lower chip 10 or 12 is connected to second electrodes of said wiring substrate 8 via a plurality of bonding wires 17, said first electrodes are arranged toward an outer periphery side of said wiring substrate from the second electrodes (fig. 1).

- Regarding claim 3, Kanemoto et al. disclose that the memory chip includes a flash memory (fig. 5, column 9, lines 36-37).
- Regarding claim 7, Hiroaki et al. disclose that the upper chip 14 is connected to first electrode of the wiring substrate 8 via a plurality of bonding wires 19, a lower chip 10 of the two chips is connected to second electrodes of the wiring substrate 8 via a plurality of bumps electrodes 9, the chip 12 is connected to third electrodes of the wiring substrate 8 via a plurality of bonding wires 17, the first electrodes are arranged toward an outer periphery of the wiring substrate from the second and third electrodes (fig. 1, abstract).
- Regarding claim 8, Kanemoto et al. disclose a semiconductor device comprising
 the memory chip includes a flash memory (fig. 5, column 9, lines 36-37) and it would
 have been obvious to one having ordinary skill in the art to form the lower chip 10 or 12
 of Hiroaki et al. includes DRAM.
- Regarding claim 9, Hiroaki et al. disclose a lower surface of the wiring substrate
 8 is formed with a plurality of bump electrodes 22 constructing external connection
 terminals (fig. 1).
- Regarding claim 10, Hiroaki et al. disclose the upper chip 14 and the lower chips 10 or 12 have respective terminals, and it would have been obvious to form a number of terminals of the upper chip being much greater than a number of terminals of the lower chips (fig. 1). Moreover, the number of terminals would have been obvious to an ordinary artisan practicing the invention because, absent evidence of disclosure of criticality for the number of terminals giving unexpected results, it is not inventive to

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discover number by routine experimentation. *In re Aller*, 220 F.2d 454, 105 USPQ 233, 235 (CCPA 1955). Furthermore, the specification contains no disclosure of either the critical nature of the claimed dimensions of any unexpected results arising therefrom. Where patentability is aid to be based upon particular chosen number or upon another variable recited in a claim, the Applicant must show that the chosen number is critical. See *In re Woodruff*, 919 F.2d 1575, 1578, 16 USPQ2d 1934, 1936 (Fed, Cir. 1990).

- Regarding claim 11, Hiroaki et al. disclose the terminals of the lower chips 10 or
 12 are arranged such that they are not superposed over the terminals of the upper chip
 14 in plan view (fig. 1).
- Regarding claim 12, Hiroaki et al. disclose that an under fill resin 21 is filled in a gap between the lower chip 10 and the wiring substrate 8 (fig. 1).

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to DiLinh Nguyen whose telephone number is (571) 272-1712. The examiner can normally be reached on 8:00AM - 6:00PM (M-F).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on (571) 272-1705. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

DLN

HOAI PHAM
PRIMARY EXAMINER

23 第1の積層体

24 第2の積層体

